

PATENT ASSIGNMENT COVER SHEET

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NATURE OF CONVEYANCE:	ASSIGNMENT
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Property Type	Number
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Total Attachments: 2	
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ASSIGNMENT

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譲受者名:
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住所:
Address(es):

DENSO CORPORATION

**1-1, Showa-cho, Kariya-city, Aichi-pref., 448-8661
Japan**

as Assignee(s), and corresponding successors, assigns or other legal representatives, the entire right, title and interest, in the United States of America, and its territories, dependencies and possessions, to certain inventions known as

発明の名称:
Title of **SEMICONDUCTOR DEVICE**
Invention:

上記発明についての米国登録特許証の出願は、
described in an application for Letters Patent of the United States executed

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as U.S. Application Serial No. filed on

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発明者はここに付随する添付書面上にリストされます。
inventor(s) listed on the attached sheet which is incorporated herein by reference.

注記: 上記日本語抄訳は、本書面の理解の助けとして付記しております。正式な解釈は英文に基づき行われます。

Note: The above Japanese text is for the purpose of helping the understanding of the reader. The interpretation of the Assignment should be based on the English text.

讓渡証(続き)
ASSIGNMENT (Cont.)

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